

#### Description

The DMP4050SSS uses advanced trench technology

to provide excellent  $R_{\text{DS}(\text{ON})},$  low gate charge and

operation with gate voltages as low as 2.5V. This

device is suitable for use as a

Battery protection or in other Switching application.

#### **General Features**

V<sub>DS</sub> =-40 V I<sub>D</sub> = -13A

 $R_{DS(ON)}$  < 19m $\Omega$  @ V<sub>GS</sub>=10V

### Application

Battery protection

Load switch

Uninterruptible power supply

## Package Marking and Ordering Information

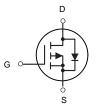
Product ID	Pack	Brand	Qty(PCS)
DMP4050SSS	SOP-8	HXY MOSFET	3000

#### Absolute Maximum Ratings (Tc=25℃ unless otherwise noted )

Symbol	Parameter	Rating	Units
Vds	Drain-Source Voltage	- 40	V
VGS	Gate-Source Voltage	±20	V
I <sub>D</sub> @T <sub>A</sub> =25℃	Drain Current <sup>3</sup> , V <sub>GS</sub> @ 10V	-13	А
IDM	Pulsed Drain Current <sup>1</sup>	-52	А
P <sub>D</sub> @T <sub>A</sub> =25℃	Total Power Dissipation	3	W
TSTG	Storage Temperature Range	-55 to 150	°C
TJ	Operating Junction Temperature Range	-55 to 150	°C
Rthj-a	Maximum Thermal Resistance, Junction-ambient <sup>3</sup>	41	°C/W



SOP-8



P-Channel MOSFET



P-Channel Enhancement Mode MOSFET

## **Electrical Characteristics (T**J = 25°C, unless otherwise noted)

Parameter		Symbol Test Conditions		Min.	Тур.	Max.	Unit	
Static Characteristics		I	1		1			
Drain-Source Breakdown Volt	reakdown Voltage $V_{(BR)DSS}$ V <sub>GS</sub> = 0V, I <sub>D</sub> = -250µA		$V_{GS} = 0V, I_D = -250 \mu A$	-40	-	-	V	
Gate-body Leakage current		lgss	$V_{DS}$ = 0V, $V_{GS}$ = ±20V	-	-	±100	nA	
Zero Gate Voltage Drain Current	TJ=25℃	ldss	V <sub>DS</sub> = -40V, V <sub>GS</sub> = 0V	-	-	-1	μA	
	T_=100°C			-	-	-100		
Gate-Threshold Voltage		V <sub>GS(th)</sub>	$V_{DS}$ = $V_{GS}$ , $I_D$ = -250 $\mu$ A	-1.0	-1.5	-2.2	V	
		_	V <sub>GS</sub> = -10V, I <sub>D</sub> = -10A	-	14.0	19		
Drain-Source On-Resistance <sup>4</sup>		R <sub>DS(on)</sub>	$V_{GS}$ = -4.5V, $I_D$ = -5 A	-	19.5 25		mΩ	
Forward Transconductance <sup>4</sup>		<b>g</b> fs	V <sub>DS</sub> = -10V, I <sub>D</sub> = -10A	-	44	-	S	
Dynamic Characteristics <sup>5</sup>								
Input Capacitance		Ciss	V <sub>DS</sub> = -20V, V <sub>GS</sub> =0V, f =1MHz	-	2525	-	pF	
Output Capacitance		Coss		-	190	-		
Reverse Transfer Capacitance		Crss		-	172	-		
Gate Resistance		Rg	f =1MHz	-	10	-	Ω	
Switching Characteristics	5 <sup>5</sup>	•					1	
Total Gate Charge		Qg		-	35	-		
Gate-Source Charge		Qgs	V <sub>GS</sub> = -10V,V <sub>DS</sub> = -20V, I <sub>D</sub> = -10A	-	5.5	-	nC	
Gate-Drain Charge		Q <sub>gd</sub>		-	8	-	1	
Turn-On Delay Time	Turn-On Delay Time			-	14.5	-	ns	
Rise Time		tr	V <sub>GS</sub> = -10V, V <sub>DD</sub> = -20V,	-	20.2	-		
Turn-Off Delay Time		t <sub>d(off)</sub>	$R_{G} = 3\Omega, I_{D} = -10A$	-	32	-		
Fall Time		tr	-	-	10	-		
Drain-Source Body Diode	Character	istics	1	1	1	1	1	
Diode Forward Voltage <sup>4</sup>		V <sub>SD</sub>	I <sub>S</sub> = -10A, V <sub>GS</sub> = 0V	-	-	-1.2	V	
Continuous Source Current	Tc=25°C	ls	-	-	_	-13	А	

Note :

1. Repetitive rating, pulse width limited by junction temperature  $T_{J(MAX)}$ =150°C.

2. The EAS data shows Max. rating . The test condition is V\_{DD}= -25V, V\_{GS}= -10V, L= 0.1mH, I\_{AS}= -34A.

- 3. The data tested by surface mounted on a 1 inch2 FR-4 board with 2OZ copper, The value in any given application depends on the user's specific board design.
- 4. The data tested by pulsed , pulse width  $\leq$  300us , duty cycle  $\leq$  2%.

5. This value is guaranteed by design hence it is not included in the production test.



# **Typical Characteristics**

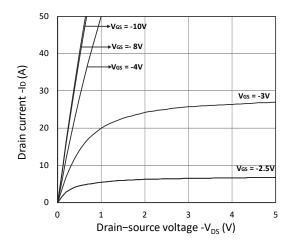


Figure 1. Output Characteristics

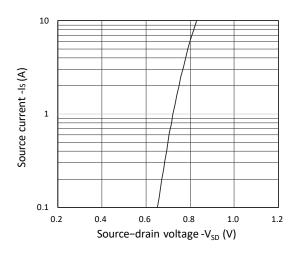


Figure 3. Forward Characteristics of Reverse

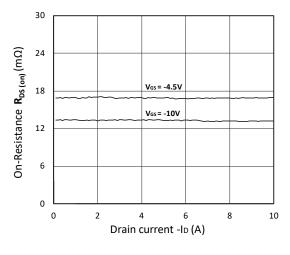


Figure 5.  $R_{DS(ON)}$  vs.  $I_D$ 

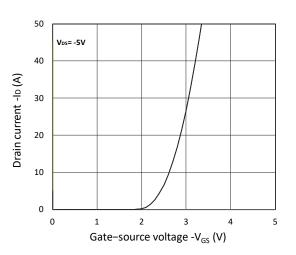


Figure 2. Transfer Characteristics

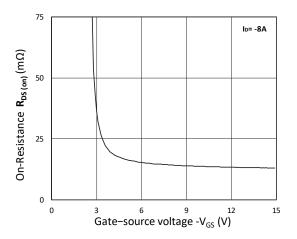


Figure 4. R<sub>DS(ON)</sub> vs. V<sub>GS</sub>

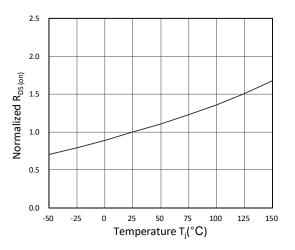


Figure 6. Normalized  $R_{DS(on)}$  vs. Temperature



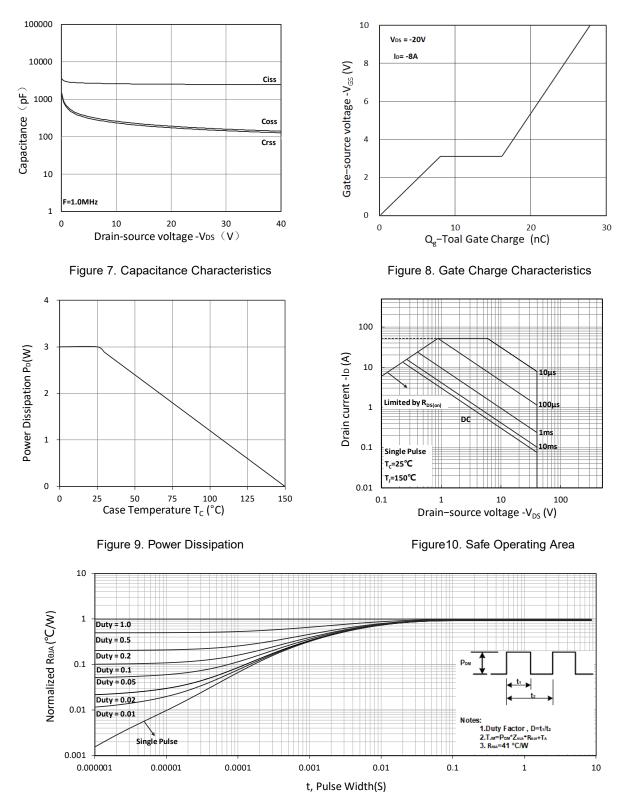
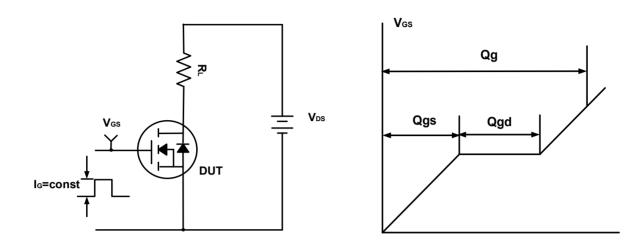


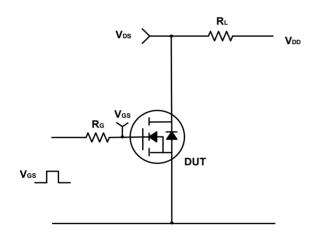
Figure 11. Normalized Maximum Transient Thermal Impedance



# **Test Circuit**









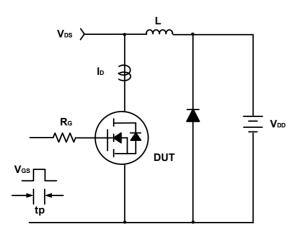
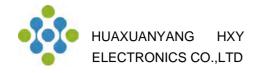
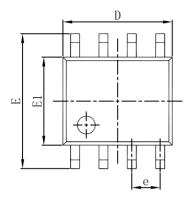
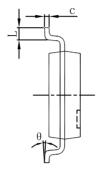


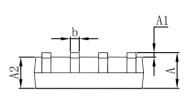
Figure C. Unclamped Inductive Switching Circuit & Waveforms



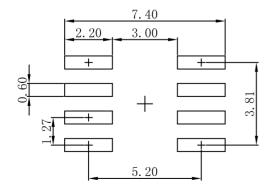
# **SOP-8 Package Outline Dimensions**







Symbol	Dimensions In Millimeters		Dimensions In Inches		
	Min	Max	Min	Max	
Α	1.350	1.750	0.053	0.069	
A1	0.100	0.250	0.004	0.010	
A2	1.350	1.550	0.053	0.061	
b	0.330	0.510	0.013	0.020	
с	0.170	0.250	0.007	0.010	
D	4.800	5.000	0.189	0.197	
e	1.270 (BSC)		0.050 (BSC)		
E	5.800	6.200	0.228	0.244	
E1	3.800	4.000	0.150	0.157	
L	0.400	1.270	0.016	0.050	
θ	0 °	8°	0 °	8°	



Note: 1.Controlling dimension: in millimeters.

2.General tolerance:± 0.05mm.
 3.The pad layout is for reference purposes only.



#### **Attention**

Any and all HUA XUAN YANG ELECTRONICS products described or contained herein do not have specifications that can handle applications that require extremely high levels of reliability, such as life-support systems, aircraft's control systems, or other applications whose failure can be reasonably expected to result in serious physical and/or material damage. Consult with your HUA XUAN YANG ELECTRONICS representative nearest you before using any HUA XUAN YANG ELECTRONICS products described or contained herein in such applications.

• HUA XUAN YANG ELECTRONICS assumes no responsibility for equipment failures that result from using products at values that exceed, even momentarily, rated values (such as maximum ratings, operating condition ranges, or other parameters) listed in products specifications of any and all HUA XUAN YANG ELECTRONICS products described or contained herein.

• Specifications of any and all HUA XUAN YANG ELECTRONICS products described or contained herein stipulate the performance, characteristics, and functions of the described products in the independent state, and are not guarantees of the performance, characteristics, and functions of the described products as mounted in the customer's products or equipment. To verify symptoms and states that cannot be evaluated in an independent device, the customer should always evaluate and test devices mounted in the customer's products or equipment.

■ HUA XUAN YANG ELECTRONICS CO.,LTD. strives to supply high-quality high-reliability products. However, any and all semiconductor products fail with some probability. It is possible that these probabilistic failures could

give rise to accidents or events that could endanger human lives, that could give rise to smoke or fire, or that could cause damage to other property. When designing equipment, adopt safety measures so that these kinds of accidents or events cannot occur. Such measures include but are not limited to protective circuits and error prevention circuits for safe design, redundant design, and structural design.

■ In the event that any or all HUA XUAN YANG ELECTRONICS products(including technical data, services) described or contained herein are controlled under any of applicable local export control laws and regulations, such products must not be exported without obtaining the export license from the authorities concerned in accordance with the above law.

• No part of this publication may be reproduced or transmitted in any form or by any means, electronic or mechanical, including photocopying and recording, or any information storage or retrieval system, or otherwise, without the prior written permission of HUA XUAN YANG ELECTRONICS CO.,LTD.

Information (including circuit diagrams and circuit parameters) herein is for example only ; it is not guaranteed for volume production.
HUA XUAN YANG ELECTRONICS believes information herein is accurate and reliable, but no guarantees are made or implied regarding its use or any infringements of intellectual property rights or other rights of third parties.

Any and all information described or contained herein are subject to change without notice due to product/technology improvement, etc.
When designing equipment, refer to the "Delivery Specification" for the HUA XUAN YANG ELECTRONICS product that you intend to use.